

P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1915 is a switching device which can be driven directly by a 2.5-V power source.

The μ PA1915 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- Can be driven by a 2.5-V power source
- Low on-state resistance

 $\begin{array}{l} R_{DS(on)1} = 55 \ m\Omega \ MAX. \ (V_{GS} = -4.5 \ V, \ I_{D} = -2.5 \ A) \\ R_{DS(on)2} = 58 \ m\Omega \ MAX. \ (V_{GS} = -4.0 \ V, \ I_{D} = -2.5 \ A) \\ R_{DS(on)3} = 82 \ m\Omega \ MAX. \ (V_{GS} = -2.7 \ V, \ I_{D} = -2.5 \ A) \\ R_{DS(on)4} = 90 \ m\Omega \ MAX. \ (V_{GS} = -2.5 \ V, \ I_{D} = -2.5 \ A) \end{array}$

★ ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1915TE	SC-95 (Mini Mold Thin Type)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	Vdss	-20	V
Gate to Source Voltage	Vgss	±12	V
Drain Current (DC)	D(DC)	±4.5	А
Drain Current (pulse) ^{Note1}	D(pulse)	±18	А
Total Power Dissipation	P T1	0.2	W
Total Power Dissipation Note2	P T2	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C

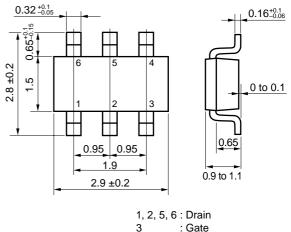
Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

- **2.** Mounted on FR-4 Board, $t \le 5$ sec.
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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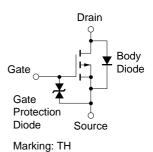
PACKAGE DRAWING (Unit : mm)



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: Gate : Source

EQUIVALENT CIRCUIT



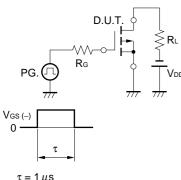
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

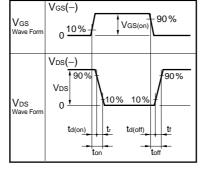
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = -20 V, Vgs = 0 V			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 12 \text{ V}, \text{ Vds} = 0 \text{ V}$			±10	μA
Gate to Source Cut-off Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ Id} = -1 \text{ mA}$	-0.5	-1.1	-1.5	V
Forward Transfer Admittance	yfs	V⊳s = −10 V, I⊳ = −2.5 A	3	8.8		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = -4.5 V, Id = -2.5 A		45	55	mΩ
	RDS(on)2	Vgs = −4.0 V, Ib = −2.5 A		47	58	mΩ
	RDS(on)3	Vgs = -2.7 V, Id = -2.5 A		61	82	mΩ
	RDS(on)4	Vgs = −2.5 V, ID = −2.5 A		67	90	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		820		pF
Output Capacitance	Coss	Vgs = 0 V		210		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		100		pF
Turn-on Delay Time	td(on)	$V_{DD} = -10 V$		16		ns
Rise Time	tr	ID = -2.5 A		14		ns
Turn-off Delay Time	td(off)	$V_{GS(on)} = -4.0 V$		58		ns
Fall Time	tr	R _G = 10 Ω		46		ns
Total Gate Charge	QG	VDD = -16 V		5.0		nC
Gate to Source Charge	Q _{GS}	ID = -4.5 A		2.0		nC
Gate to Drain Charge	Qgd	Vgs = -4.0 V		2.5		nC
Diode Forward Voltage	V _{F(S-D)}	IF = 4.5 A, Vgs = 0 V		0.86		V

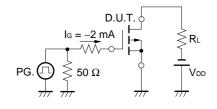
TEST CIRCUIT 1 SWITCHING TIME

VDD

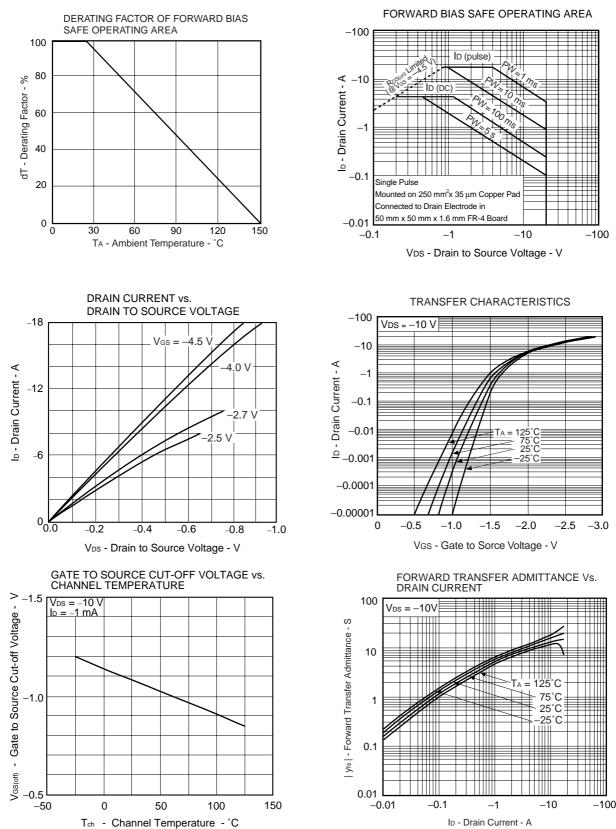




TEST CIRCUIT 2 GATE CHARGE

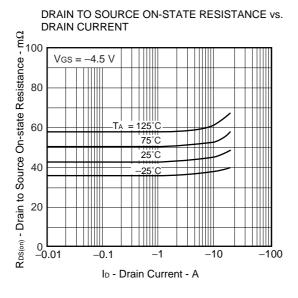


 $\tau = 1 \, \mu s$ Duty Cycle \leq 1 % *

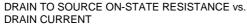


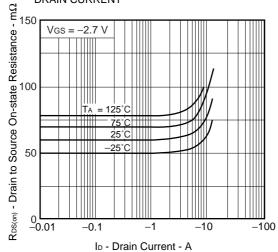
TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

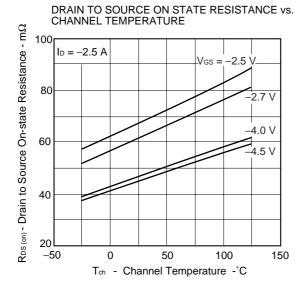
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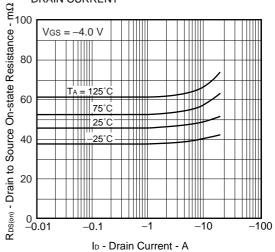
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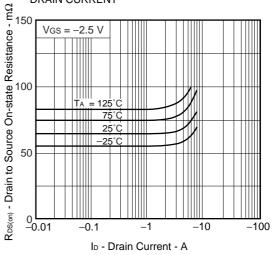




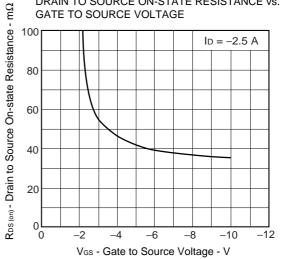
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



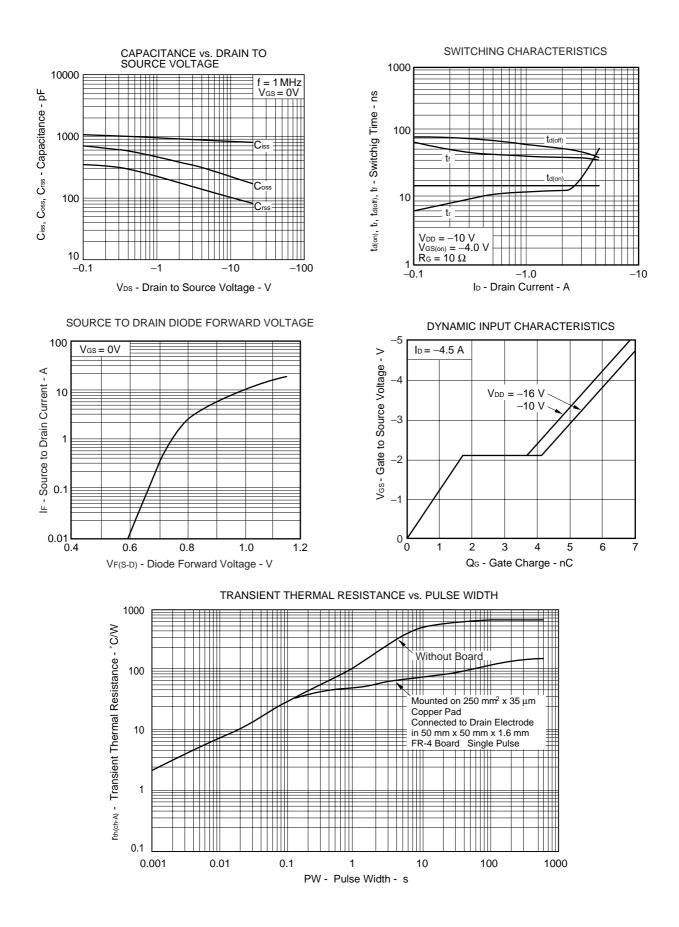
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



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